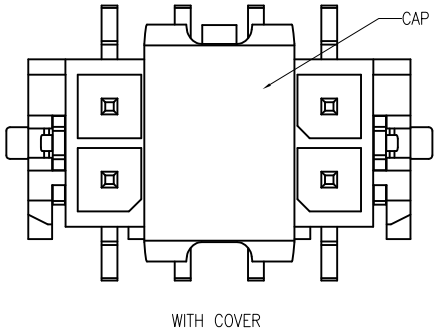
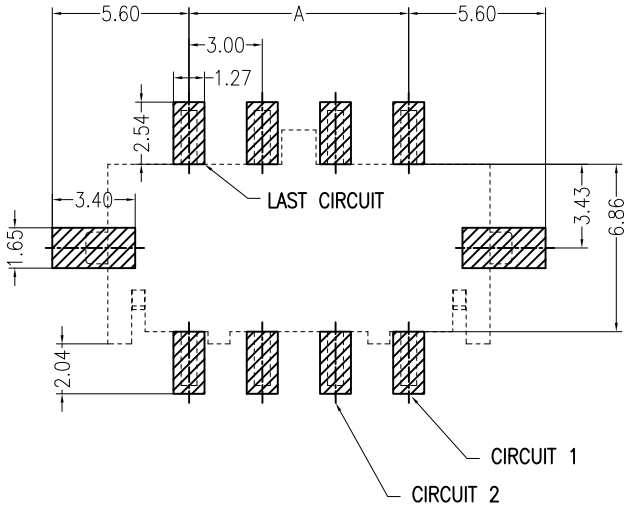
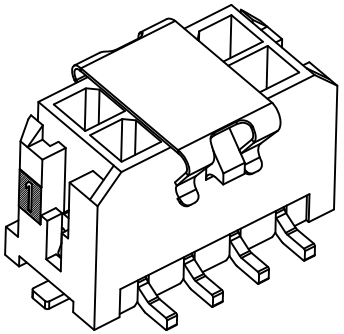
REV	DESCRIPTION	DESIGN	DATE
A0	NEW RELEASE	Lingqing	2019/08/08





PCB LAYOUT(Tolerance:±0.05)



PIN	DIM A	DIM B
2x2	3.00	9.65
2x3	6.00	12.65
2x4	9.00	15.65
2x5	12.00	18.65
2x6	15.00	21.65
2x7	18.00	24.65
2x8	21.00	27.65
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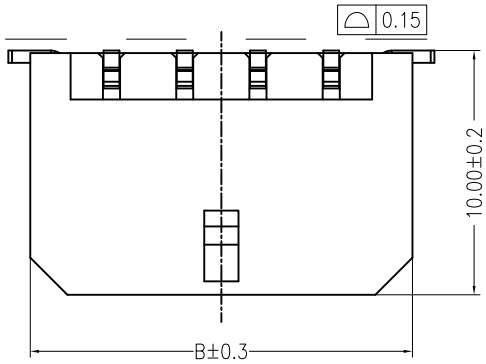
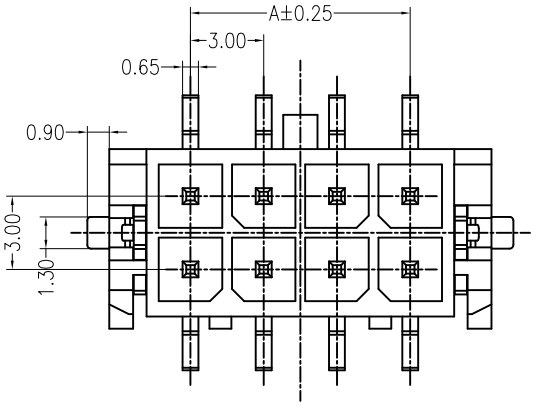
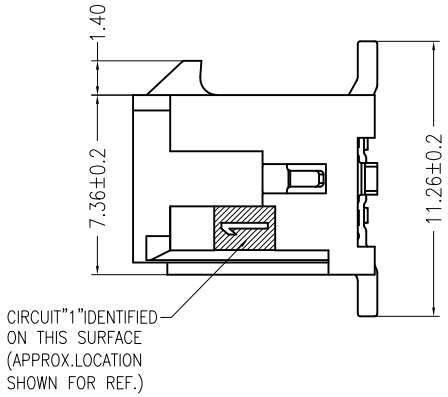
2x10	27.00	33.65
2x11	30.00	36.65
2x12	33.00	39.65



Specifications:

Contact resistance:≤10mΩ
Insulation resistance:⩾1000MΩ
Rated voltage:250V AC DC
Rated current:5.0A AC DC
Withstand Voltage: 1000V AC/minute
Temperature Range: −40℃～ +105℃
Housing:LCP UL94V−0,BLACK
Contacts:Brass/MATTE Sn−plated
Solder Tabs:Brass/MATTE Sn−plated





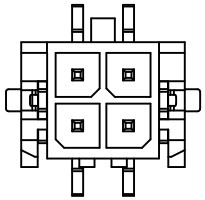
ORDER INFORMATION:

A3001AWV−2**−F9KB3−R−X

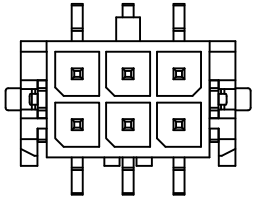
- PART No.
- No.OF CIRCUITS: 02−24
- PLASTIC MATERIAL: F9K=LCP
- PLATING: B=MATTE Sn
- Metal code: 3=Brass
- PACKAGING: R=REEL
- SPECIAL CODE: X=Cap

骇米科技电子（深圳）有限公司湖南分公司 HM Technology Electronice Co., Ltd			TITLE: 3.0 Pitch Wafer 180° SMT
GENERAL TOLERANCE		USE: CUSTOMER	PART NO.: A3001AWV−2**−F9KB3−R−X
X. ±0.50	X. ±5°	APPD: Liuzhengling	DWG NO.: GCKH−0813
X.X ±0.30	X.X ±2°	CHKD: Steven	SCALE 1 : 1 / SHEET 1 / 2
X.XX ±0.20	X.XX ±1°	DR: Zenglingqing	
	UNITS: mm		

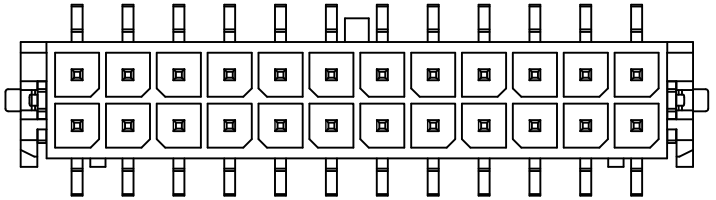
REV	DESCRIPTION	DESIGN	DATE
A0	NEW RELEASE	Lingqing	2019/08/08



2x2P



2x3P



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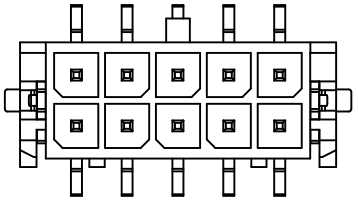

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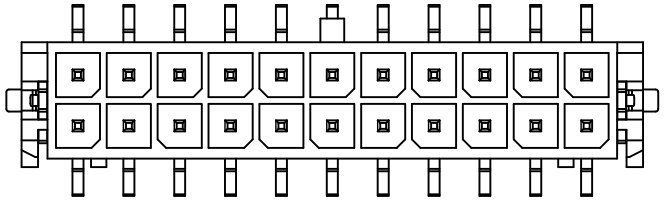

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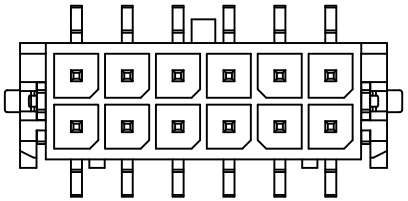
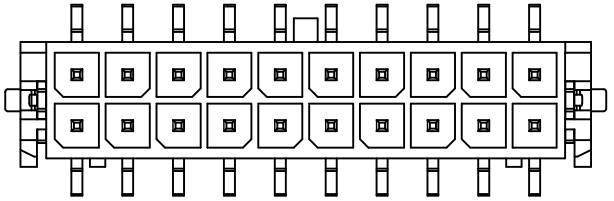


2x6P



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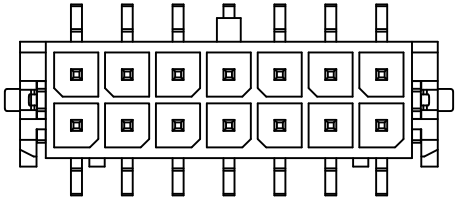

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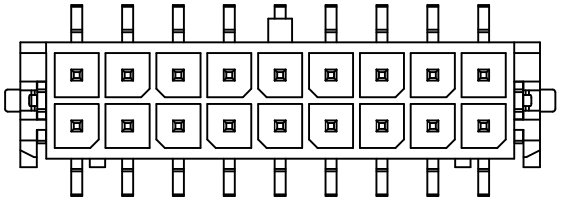
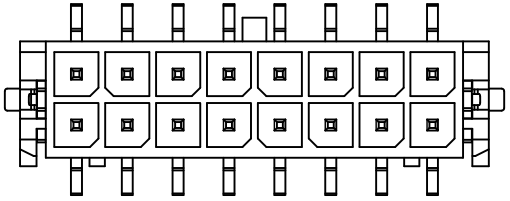


2x9P



2x8P

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GENERAL TOLERANCE		USE: CUSTOMER	PART NO.: A3001AWV-2**-F9KB3-R-X
X. ±0.50	X. ±5°	APPD: Liuzhengling	DWG NO.: GCKH-0813
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X.XX ±0.20	X.XX ±1°	DR: Zenglingqing	
	UNITS: mm		